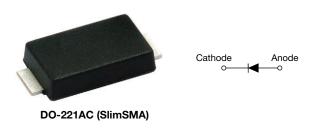
Vishay Semiconductors

Hyperfast Rectifier, 3 A FRED Pt[®]



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PRODUCT SUMMARY				
Package	DO-221AC (SlimSMA)			
I _{F(AV)}	3 A			
V _R	200 V			
V _F at I _F	0.74 V			
t _{rr}	30 ns			
T _J max.	175 °C			
Diode variation	Single die			

FEATURES

- Hyperfast recovery time, reduced Q_{rr}, and soft recovery
- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in snubber, boost, lighting, piezo-injection, as high frequency rectifiers and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Peak repetitive reverse voltage	V _{RRM}		200	V	
Average rectified forward current	I _{F(AV)}	$T_{\rm C} = 145 \ ^{\circ}{\rm C}^{(1)}$	3	v	
Non-repetitive peak surge current	I _{FSM}	T _J = 25 °C	85	А	
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C	

Note

⁽¹⁾ Device on PCB with 8 mm x 16 mm soldering lands

ELECTRICAL SPECIFICATIONS (T _J = 25 $^{\circ}$ C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-	
Forward voltage	VF	I _F = 3 A	-	0.86	0.93	V
Torward voltage	۷F	I _F = 3 A, T _J = 125 °C	-	0.74	0.78	
Reverse leakage current	1	$V_{R} = V_{R}$ rated	-	-	2	
Reverse leakage current	I _R	$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	1	8	μA
Junction capacitance	CT	V _R = 200 V	-	13	-	pF

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RoHS

COMPLIANT HALOGEN

FREE



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DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 50$	0 A/µs, V _R = 30 V	-	26	-	
Reverse recovery time	a cover time	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A		-	-	30	
neverse recovery time	t _{rr}	T _J = 25 °C		-	18	-	ns
	T _J = 125 °C		-	26	-		
Posk receivery surrent		T _J = 25 °C	$I_F = 3 A$	-	2.5	-	А
Peak recovery current	eak recovery current	T _J = 125 °C	dI _F /dt = 200 A/µs V _B = 160 V	-	4	-	~
	Reverse recovery charge Q _{rr}	T _J = 25 °C		-	23	-	nC
neverse recovery charge		T _J = 125 °C		-	50	-	no

THERMAL - MECHAN		CIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C
Thermal resistance, junction to case	R _{thJC}	Device mounted on PCB with 8 mm x 16 mm soldering lands	-	-	10	°C/W
Thermal resistance, junction to ambient	R _{thJA}	Device mounted on PCB with 2 mm x 3.5 mm soldering lands	-	-	110	C/W
Approximate Weight				0.032		g
				0.0011		oz.
Marking device		Case style DO-221AC (SlimSMA)		31	H2	

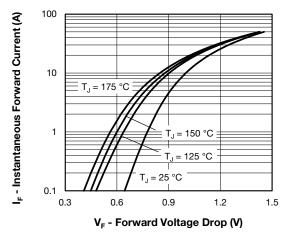
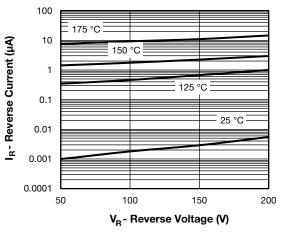
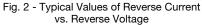


Fig. 1 - Typical Forward Voltage Drop Characteristics







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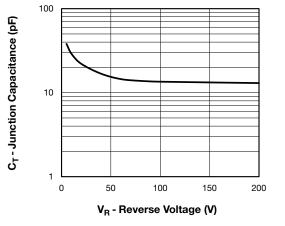


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

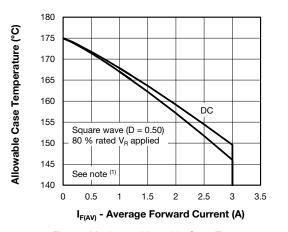
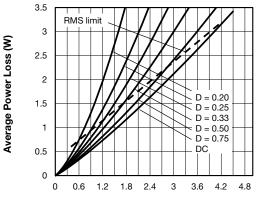


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current



Average Forward Current - I_{F(AV)} (A)

Fig. 5 - Forward Power Loss Characteristics

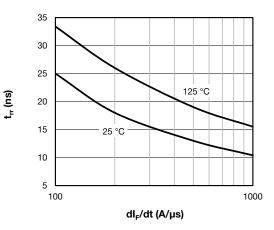


Fig. 6 - Typical Reverse Recovery vs. dl_F/dt

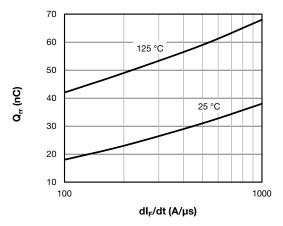


Fig. 7 - Typical Stored Charge vs. dl_F/dt

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

 $\begin{array}{l} \mbox{Pd} = \mbox{forward power loss} = \mbox{I}_{F(AV)} \times \mbox{V}_{FM} \mbox{ at } (\mbox{I}_{F(AV)}/\mbox{D}) \mbox{ (see Fig. 6);} \\ \mbox{Pd}_{REV} = \mbox{inverse power loss} = \mbox{V}_{R1} \times \mbox{I}_{R} \mbox{ (1 - D); I}_{R} \mbox{ at } \mbox{V}_{R1} = \mbox{rated } \mbox{V}_{R} \end{array}$

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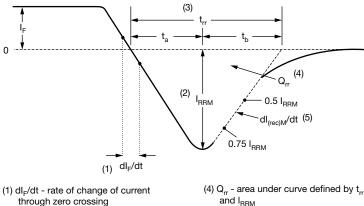
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VS-3EJH02HM3

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- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.

and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) dl_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 8 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

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Device code	VS-	3	Е	J	н	02	н	М3
		2	3	4	5	6	7	8
	1 ·	- Visl	nay Sen	niconduo	ctors pro	oduct		
	2 -	- Cur	rent rati	ng (3 = 3	3 A)			
	3 -	· Circ	cuit conf	iguratior	า:			
		E =	single o	liode				
	4 -	. J=	SlimSM	A packa	ige			
	5 -	· Pro	cess typ	e,				
		H =	hyperfa	ist recov	very			
	6 -	Vol	tage coo	le (02 =	200 V)			
	7 -	. н=	AEC-Q	101 qua	lified			
	8 -	• M3	= halog	en-free,	RoHS-0	complia	nt, and	termina

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-3EJH02HM3/6A	3500	3500	7"diameter plastic tape and reel			
VS-3EJH02HM3/6B	14 000	14 000	13"diameter plastic tape and reel			

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95571			
Part marking information	www.vishay.com/doc?95562			
Packaging information	www.vishay.com/doc?88869			
SPICE model	www.vishay.com/doc?96050			

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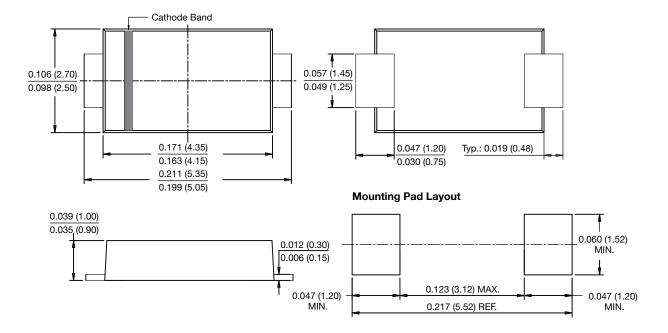
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DO-221AC (SlimSMA)

DIMENSIONS in inches (millimeters)





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